

1.5A Ultra-small Load Switch with Slew Rate Control

FEATURES

Integrated P-channel MOSFET load switch

Input voltage: 1.2V to 5.5V

1.5A maximum continuous switch current

Switch on-resistance(typ.):

Rdson= $50m\Omega$ at $V_{IN}=5.5V$

Rdson= $56m\Omega$ at $V_{IN}=4.2V$

Rdson= $64m\Omega$ at $V_{IN}=3.3V$

Rdson= $78m\Omega$ at $V_{IN}=2.5V$

Rdson=109m Ω at V_{IN} =1.8V

Rdson= $225m\Omega$ at $V_{IN}=1.2V$

Controlled slew rate to limit inrush current

Internal EN Pull-Down Resistor

Quick output discharge

FOWLP 0.76mm×0.76mm×0.50mm-4B package

APPLICATIONS

- Smartphones and Tablets
- Portable Devices
- Wearables

GENERAL DESCRIPTION

The AW35121 is a load switch with output slew rate control. The device integrates a $64m\Omega$ (typ.) P-channel MOSFET, which can operate over a wide input range of 1.2V to 5.5V.

The AW35121 features output slew rate control, limiting inrush current during turn-on to protect downstream devices.

TYPICAL APPLICATION CIRCUITS

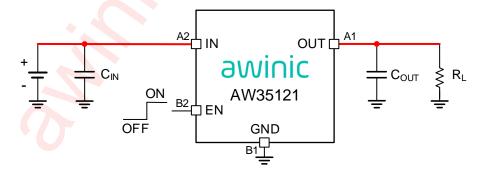


Figure 1 Typical Application circuit of AW35121

1



PIN CONFIGURATION AND TOP MARK

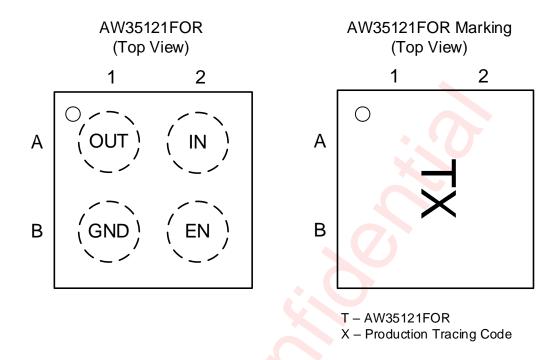


Figure 2 Pin Configuration and Top Mark

PIN DEFINITION

Pin	Name	Description
A1	OUT	Switch output
A2	IN	Switch input and power supply
B1	GND	Device ground
B2	EN	Switch control input, active high, internal 6.85MΩ pull down resistor.

FUNCTIONAL BLOCK DIAGRAM

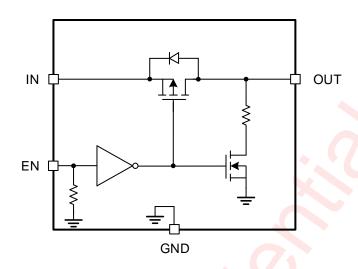


Figure 3 Functional Block Diagram

TYPICAL APPLICATION CIRCUITS

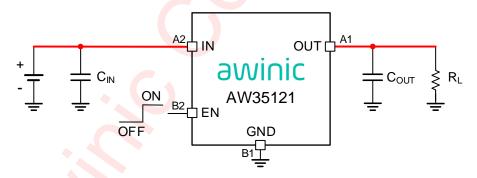


Figure 4 Typical Application circuit of AW35121

ORDERING INFORMATION

Part Number	Temperature	Package	Package Marking Moisture Sensitivity Level		Environmental Information	Delivery Form
AW35121FOR	-40°C∼85°C	FOWLP 0.76mm×0.76 mm-4B	Т	MSL1	ROHS+HF	3000 units/ Tape and Reel



ABSOLUTE MAXIMUM RATINGS(NOTE1)

PARAMETER	RANGE				
Supply Voltage Rai	Supply Voltage Range V _{IN}				
Input Voltage Range	Input Voltage Range EN				
Output Voltage Range	OUT	-0.3V to 6V			
Maximum Continuous Switch Curre	ent for VIN ≥ 2V ^(NOTE 2)	1.5A			
Maximum Peak Switch Current for	or VIN $\geq 2.5V^{(NOTE 3)}$	2A			
Junction-to-ambient Thermal R	esistance θ _{JA} (NOTE 4)	184°C/W			
Operating Free-air Tempe	rature Range	-40°C to 85°C			
Maximum Junction Temp	150°C				
Storage Temperatu	-65°C to 150°C				
Lead Temperature (Solderin	260°C				
HBM (Human Body Mo	±2kV				
CDM(Charged Device N	±1.5kV				
MM(Machine Model	±200V				
Latch-Up (NOTE	Lotob Lin (NOTE 8)				
Laton-Op v		-IT: -200mA			

NOTE1: Conditions out of those ranges listed in "absolute maximum ratings" may cause permanent damages to the device. In spite of the limits above, functional operation conditions of the device should within the ranges listed in "recommended operating conditions". Exposure to absolute-maximum-rated conditions for prolonged periods may affect device reliability.

NOTE2: Limited by thermal design.

NOTE3: Limited by thermal design, and tested in 10ms width pulse current.

NOTE4: Thermal resistance from junction to ambient is highly dependent on PCB layout.

NOTE5: The human body model is a 100pF capacitor discharged through a 1.5k Ω resistor into each pin. Test method: ESDA/JEDEC JS-001-2017.

NOTE6: All pins. Test Condition: ESDA/JEDEC JS-002-2014.

NOTE7: All pins. Test Condition: JESD22-A115C.

NOTE8: Test Condition: JESD78E.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Тур.	Max.	Unit
V _{IN}	Input Voltage			5.5	V
VEN	EN Voltage	0		5.5	V
Vout	Output Voltage			V _{IN}	V
CIN	Input capacitance		1		μF
Соит	Output load capacitance	0.1	1		μF



ELECTRICAL CHARACTERISTICS

 T_A = -40°C to 85°C unless otherwise noted. Typical values are guaranteed for V_{IN} = 5V, C_{IN} = 1 μ F, I_{IN} ≤ 1.5A and T_A = 25°C.

PARAMETER		TEST CONDITION	MIN	TYP	MAX	UNIT
INPUT (CURRENTS					
		V _{IN} =3.3V, V _{EN} =3.3V, I _{OUT} =0A, T _A =25°C	4	2	12	nA
	Input quiescent	V _{IN} =3.3V, V _{EN} =3.3V, I _{OUT} =0A, T _A =85°C		9		nA
lα	current	V _{IN} =5.5V, V _{EN} =5.5V, I _{OUT} =0A, T _A =25°C	\	5	25	nA
		V _{IN} =5.5V, V _{EN} =5.5V, I _{OUT} =0A, T _A =85°C		10		nA
		V _{IN} =1.2V, V _{EN} =0V, T _A =25°C		2		nA
		V _{IN} =1.8V, V _{EN} =0V, T _A =25°C		2		nA
		V _{IN} =3.3V, V _{EN} =0V, T _A =25°C		4	44	nA
	Shutdown	V _{IN} =4.0V, V _{EN} =0V, T _A =25°C		7		nA
I _{SD}	current from IN	V _{IN} =4.5V, V _{EN} =0V, T _A =25°C		22		nA
	to GND	V _{IN} =5.0V, V _{EN} =0V, T _A =25°C		62	970	nA
		V _{IN} =5.0V, V _{EN} =0V, T _A =55°C		90		nA
		V _{IN} =5.0V, V _{EN} =0V, T _A =85°C		350		nA
		$V_{IN}=5.5V$, $V_{EN}=0V$, $T_A=25$ °C		171		nA
ILEAKEN	EN pin leakage current	V _{IN} =0V, V _{EN} =5.0V			1.5	μΑ
R _{EN}	EN pin pull down resistor	V _{EN} =5.0V		6.85		МΩ
POWER	SWITCH					
		V _{IN} =5.5V, V _{EN} =high, I _{OUT} =200mA, T _A =25°C		50		
		V _{IN} =4.2V, V _{EN} =high, I _{OUT} =200mA, T _A =25°C		56		
R _{dson}	Internal switch MOSFET on-	V _{IN} =3.3V, V _{EN} =high, I _{OUT} =200mA, T _A =25°C		64		mΩ
I X ason	state resistance	V _{IN} =3.0V, V _{EN} =high, I _{OUT} =200mA, T _A =25°C		68	120	11152
		V _{IN} =1.8V, V _{EN} =high, I _{OUT} =200mA, T _A =25°C		109		
		V_{IN} =1.2V, V_{EN} =high, I_{OUT} =200mA, T_A =25°C		225		
R _{DIS}	Output discharge resistance	V _{IN} =3.3V, V _{EN} =low, T _A =25°C, I _{OUT} Sinking 2mA	50	75	100	Ω
t R	Output rise time	V _{IN} =3.6V, C _{OUT} =1μF, R _{OUT} =30Ω		165		μs
t _F	Output fall time	V_{IN} =3.6V, C_{OUT} =1 μ F, R_{OUT} =30 Ω		42		μs
ton	Switch turn on time	V_{IN} =3.6 V , C_{OUT} =1 μ F, R_{OUT} =30 Ω		238		μs



PA	RAMETER	TEST CONDITION	MIN	TYP	MAX	UNIT
toff	Switch turn off time	V _{IN} =3.6V, C _{OUT} =1μF, R _{OUT} =30Ω		12		μs
t _{EN}	Enable time	V_{IN} =3.6V, C_{OUT} =1 μ F, R_{OUT} =30 Ω		130		μs
VIH	EN input high threshold level		1.2			V
VIL	EN input low threshold level				0.5	V

TIMING DIAGRAM

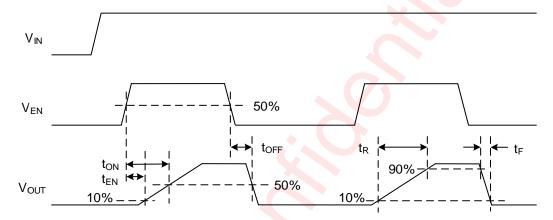
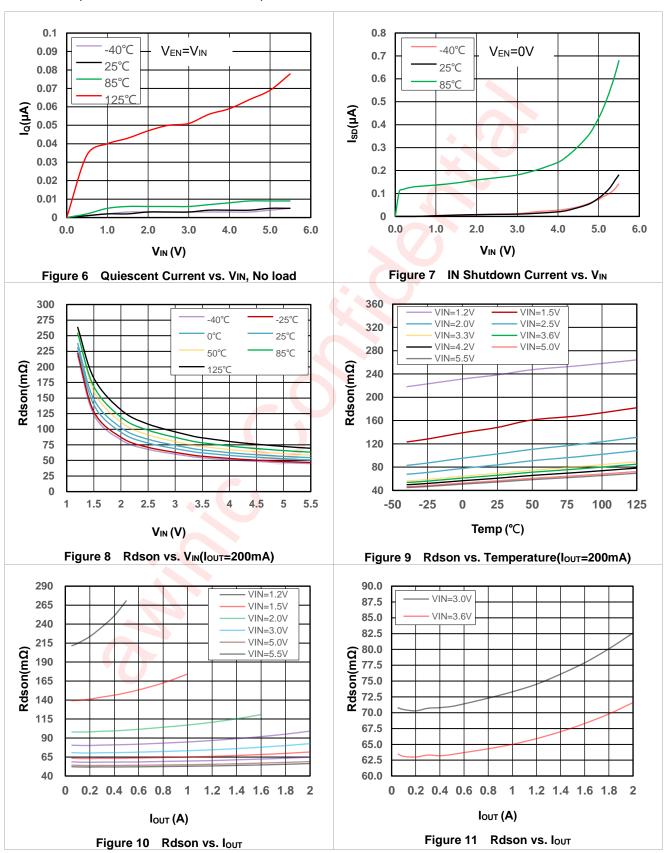


Figure 5 AW35121 Timing Diagram

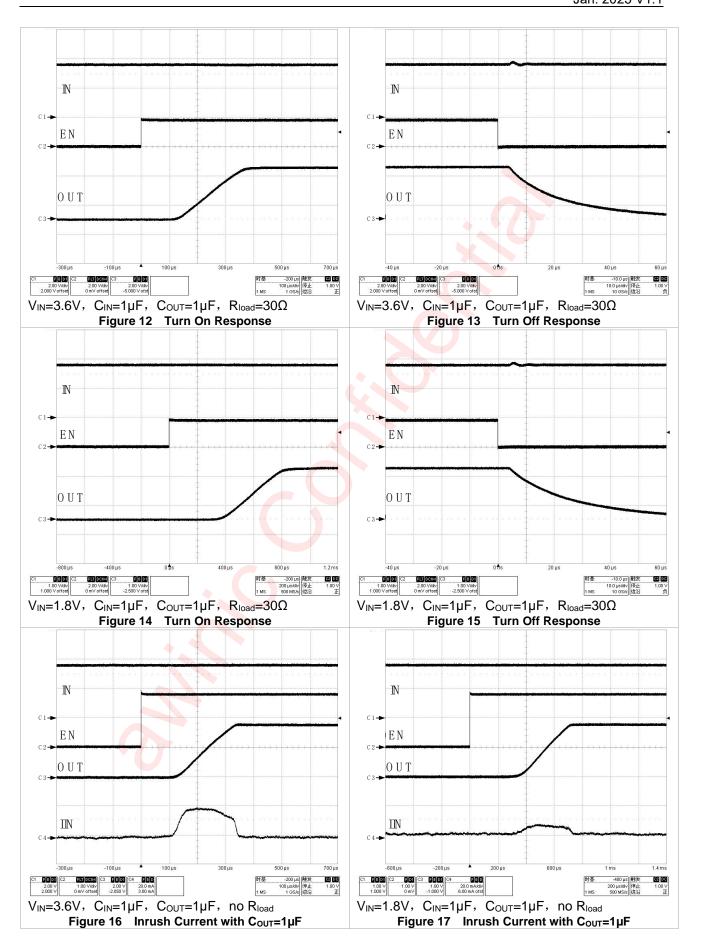


TYPICAL CHARACTERISTICS

Ambient temperature is 25°C, $C_{IN} = C_{OUT} = 1\mu F$, unless otherwise noted.









DETAILED FUNCTIONAL DESCRIPTION

The AW35121 integrates a high side P channel MOSFET load switch, and provides a low on-resistance for a low voltage drop across the device. A controlled slew rate is used in applications to limit the inrush current. The part can be turned on, with a supply voltage from 1.2V to 5.5V.

TURN ON/OFF CONTROL

Enable pin is active high. The device is opened when EN pin is tied low (disable) or pulled down by internal $6.85M\Omega$ resistor, forcing PMOS switch off. The IN/OUT path is activated with a minimum Vin of 1.2V and EN forced to high level.

Table 1. Functional Table

EN	IN to OUT	OUT to GND
Low	OFF	ON
High	ON	OFF

SLEW RATE CONTROL

When the switch is enabled, the device regulates the gate voltage of MOSFET, and controls the V_{OUT} slew rate during t_R to avoid a large input inrush current. The feature reduces the interference to the power supply.

QUICK OUTPUT DISCHARGE

The AW35121 includes the Quick Output Discharge (QOD) feature, in order to discharge the application capacitor connected on OUT pin. When EN pin is set to low level (disable state), a discharge resistance with a typical value of 75Ω connected between the output and ground, pulls down the output and prevents it from floating.



APPLICATION INFORMATION

POWER SUPPLY RECOMMENDATIONS

The device is designed to operate with a V_{IN} range of 1.2V to 5.5V. This supply must be well regulated and placed as close to the device terminals as possible. It must also be able to withstand all transient and load currents, using a recommended input capacitance of $1\mu F$ if necessary. If the supply is located more than a few inches from the device terminals, additional bulk capacitance may be required in addition to the ceramic bypass capacitors. If additional bulk capacitance is required, an electrolytic, tantalum, or ceramic capacitor of $10\mu F$ may be sufficient.

MANAGING INRUSH CURRENT

When the switch is enabled, the output capacitors must be charged up from 0V to V_{IN} . A input inrush current will appear. The Inrush current can be calculated using Equation 1:

$$linrush = Cout \frac{dVout}{dt}$$
 (1)

where:

- C_{OUT} = Output capacitance
- dV_{OUT} = Output voltage, equals to V_{IN}
- dt = Rise time t_R.

The AW35121 offers a controlled slew rate for minimizing inrush current.

POWER DISSIPATION

The power dissipation produced by the power MOSFET Rdson in ON-state can be calculated with the following equation:

$$P_{D} = Rdson \times (I_{OUT})^{2}$$
 (2)

Where:

- P_D = Power dissipation (W)
- Rdson = Power MOSFET on resistance (Ω)
- Iout = Output current (A)

THERMAL CONSIDERATIONS

Main contributor in term of junction temperature T_J(max) is the power dissipation, and T_J(max) should be restricted to 125°C under ON-state. Junction temperature is directly proportional to power dissipation in the device, it can be calculated by the following equation:

$$T_{J} = T_{A} + R_{\theta JA} \times P_{D} \tag{3}$$

Where:

- T_J = Junction temperature of the device
- T_A = Ambient temperature
- P_D = Power dissipation of the device
- ReJA = Junction to ambient thermal resistance. This parameter is highly dependent on board layout.



PCB LAYOUT CONSIDERATION

AW35121 is a low ON-Resistance load switch. In order to obtain the optimal performance, PCB layout should be considered carefully. Here are some guidelines:

- 1. All the peripherals should be placed as close to the device as possible. Place the input capacitor C_{IN} on the top layer (same layer as the AW35121) and close to IN pin, and place the output capacitor C_{OUT} on the top layer (same layer as the AW35121) and close to OUT pin.
- 2. The AW35121 integrate an up to 1.5A rated PMOS FET, and the PCB design rules must be respected to properly evacuate the heat out of the silicon. By increasing PCB area, especially around IN and OUT pins, the $R\theta_{JA}$ of the package can be decreased, allowing higher power dissipation. Blue bold paths on Figure 18 are power lines that will flow large current, please route them on PCB as straight, wide and short as possible.
- 3. Use rounded corners on the power trace from the power supply connector to AW35121 to decrease EMI coupling.

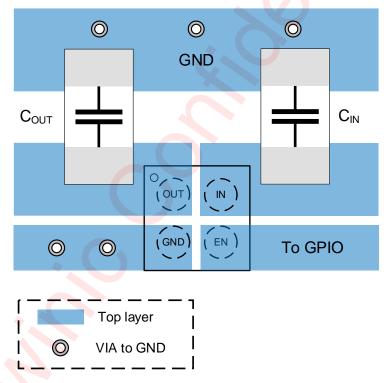
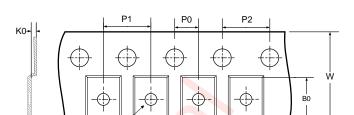


Figure 18 PCB layout example



TAPE AND REEL INFORMATION

REEL DIMENSIONS D1 0

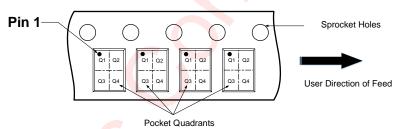


TAPE DIMENSIONS

- A0: Dimension designed to accommodate the component width
- B0: Dimension designed to accommodate the component length
- K0: Dimension designed to accommodate the component thickness
- W: Overall width of the carrier tape
- P0: Pitch between successive cavity centers and sprocket hole
- P1: Pitch between successive cavity centers
- P2: Pitch between sprocket hole
- D1: Reel Diameter
- D0: Reel Width

Cavity

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



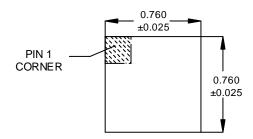
Note: The above picture is for reference only. Please refer to the value in the table below for the actual size

DIMENSIONS AND PIN1 ORIENTATION

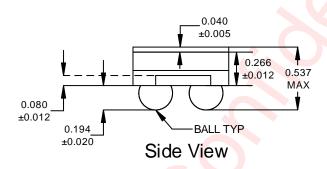
D1		_	В0	_			P2		Pin1 Quadrant
(mm)	Pini Quadrant								
179	9.2	0.85	0.85	0.59	2	4	4	8	Q1

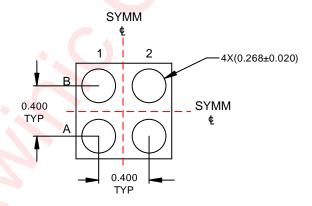
All dimensions are nominal

PACKAGE DESCRIPTION



Top View

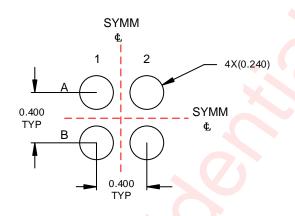


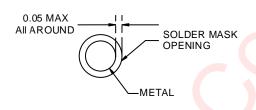


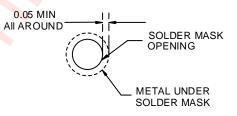
Bottom View

Unit: mm

LAND PATTERN DATA







NON-SOLDER MASK DEFINED

SOLDER MASK DEFINED

Unit: mm



REVISION HISTORY

	Version	Date	Change Record
V1.0 Nov 2019 Datasheet V1.0 Released		Nov 2019	Datasheet V1.0 Released
	V1.1	Jan 2023	Modified Pin Configuration and Top Mark; Modified Figure 18 PCB layout example.



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